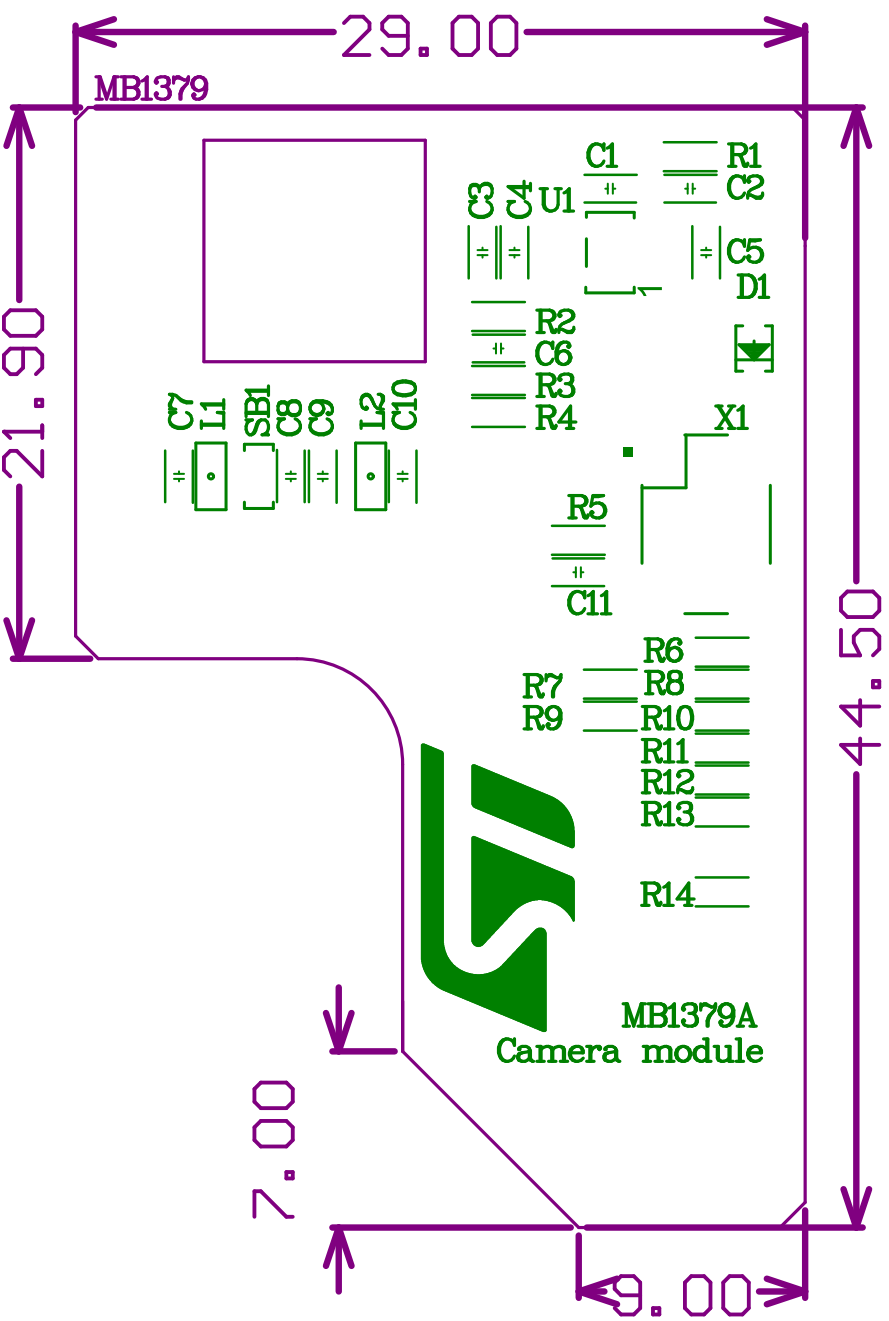
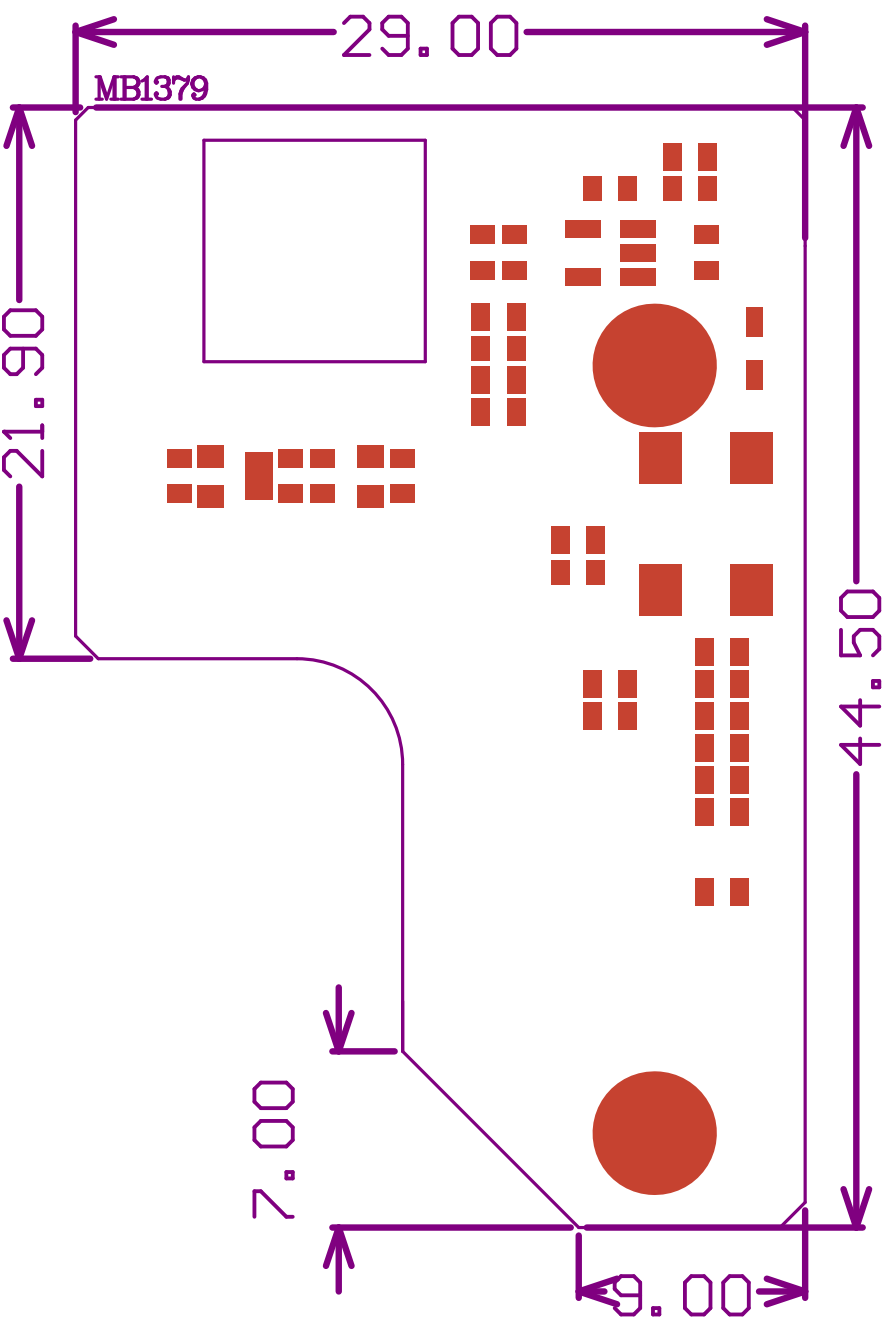
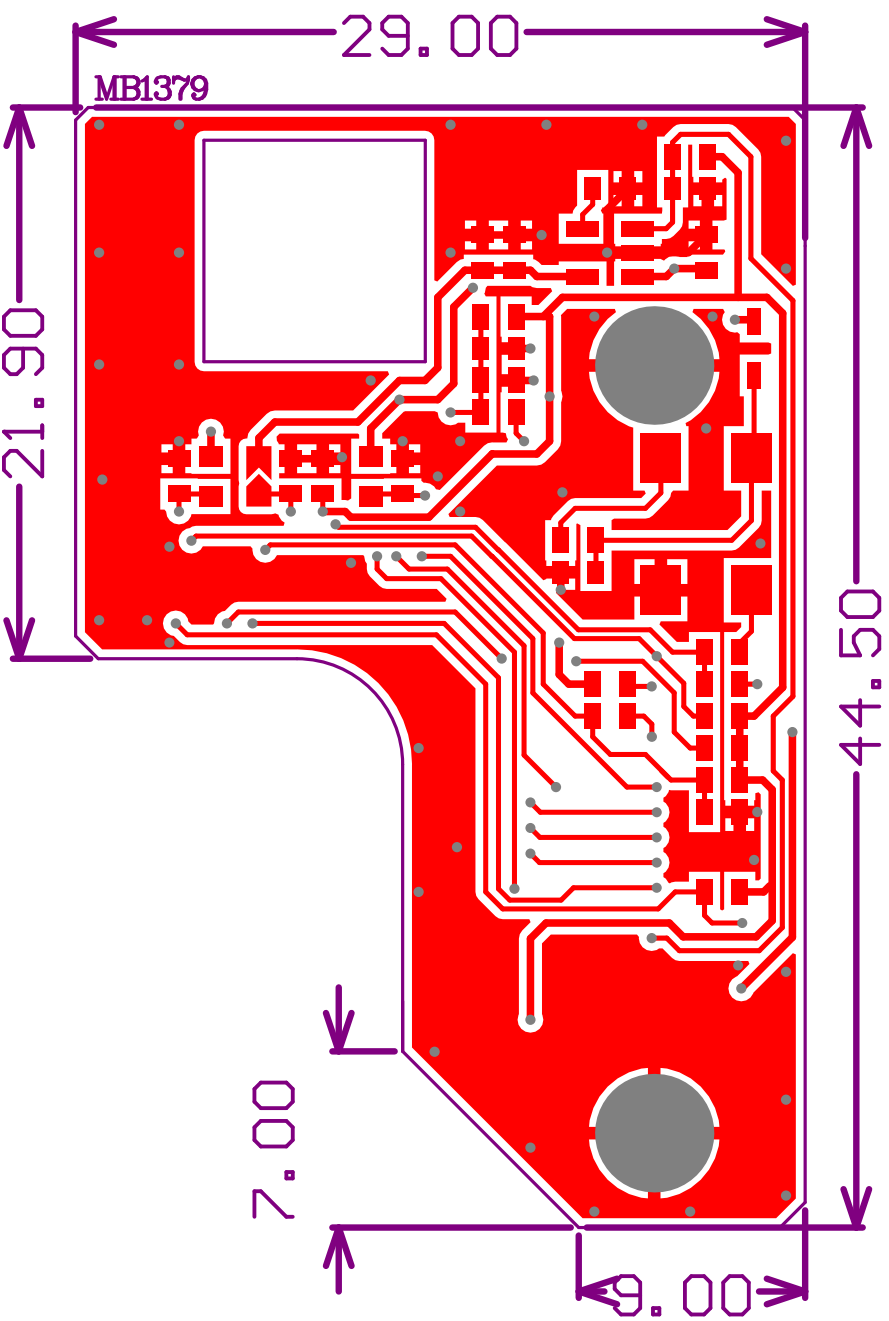


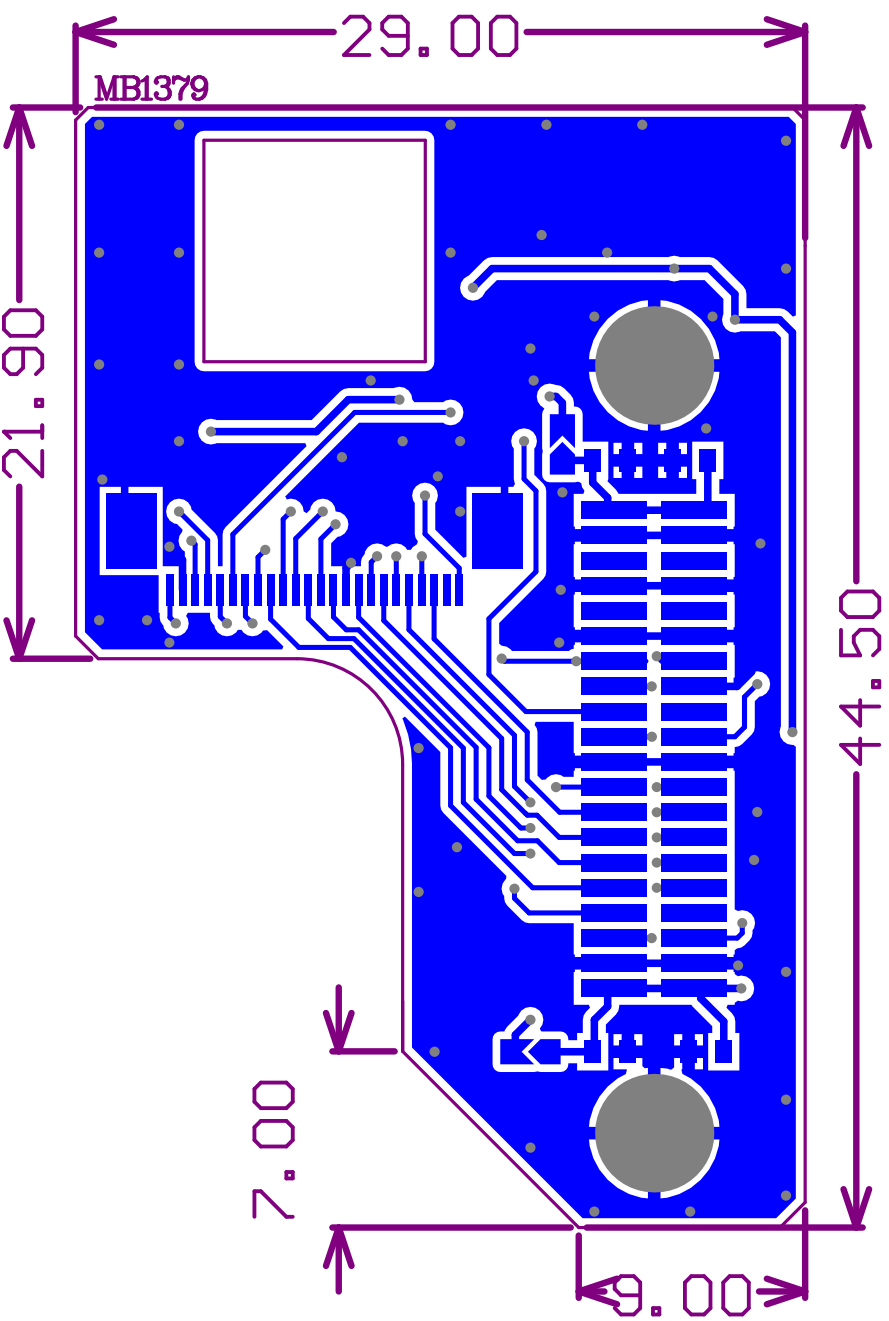
# Board Stack Report

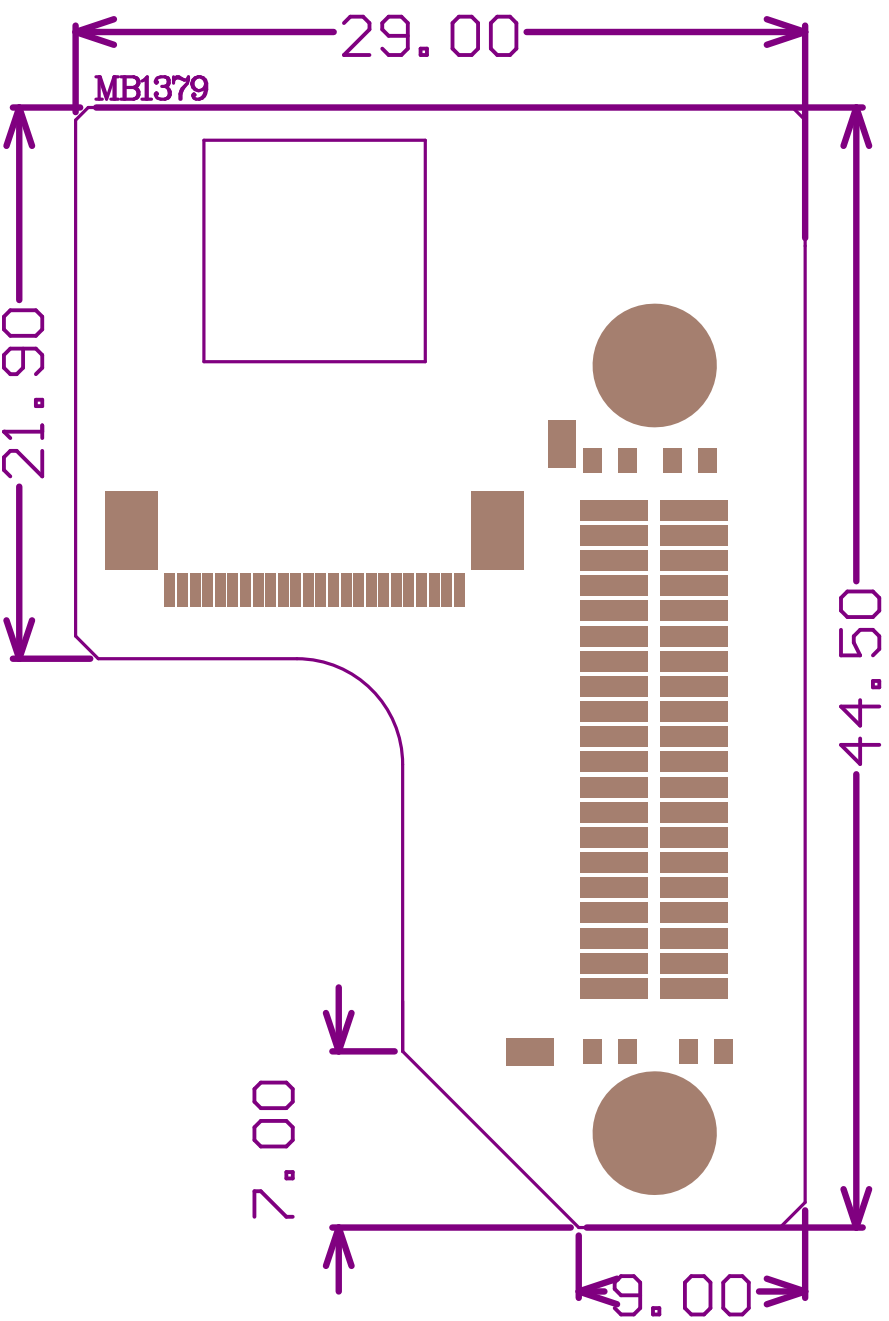
Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.036mm	
5		Dielectric1	FR-4	1.500mm	4.8
6		Bottom Layer	Copper	0.036mm	
7		Bottom Solder	Solder Resist	0.010mm	3.5
8		Bottom Overlay			
9		Bottom Paste			
	Height : 1.591mm				

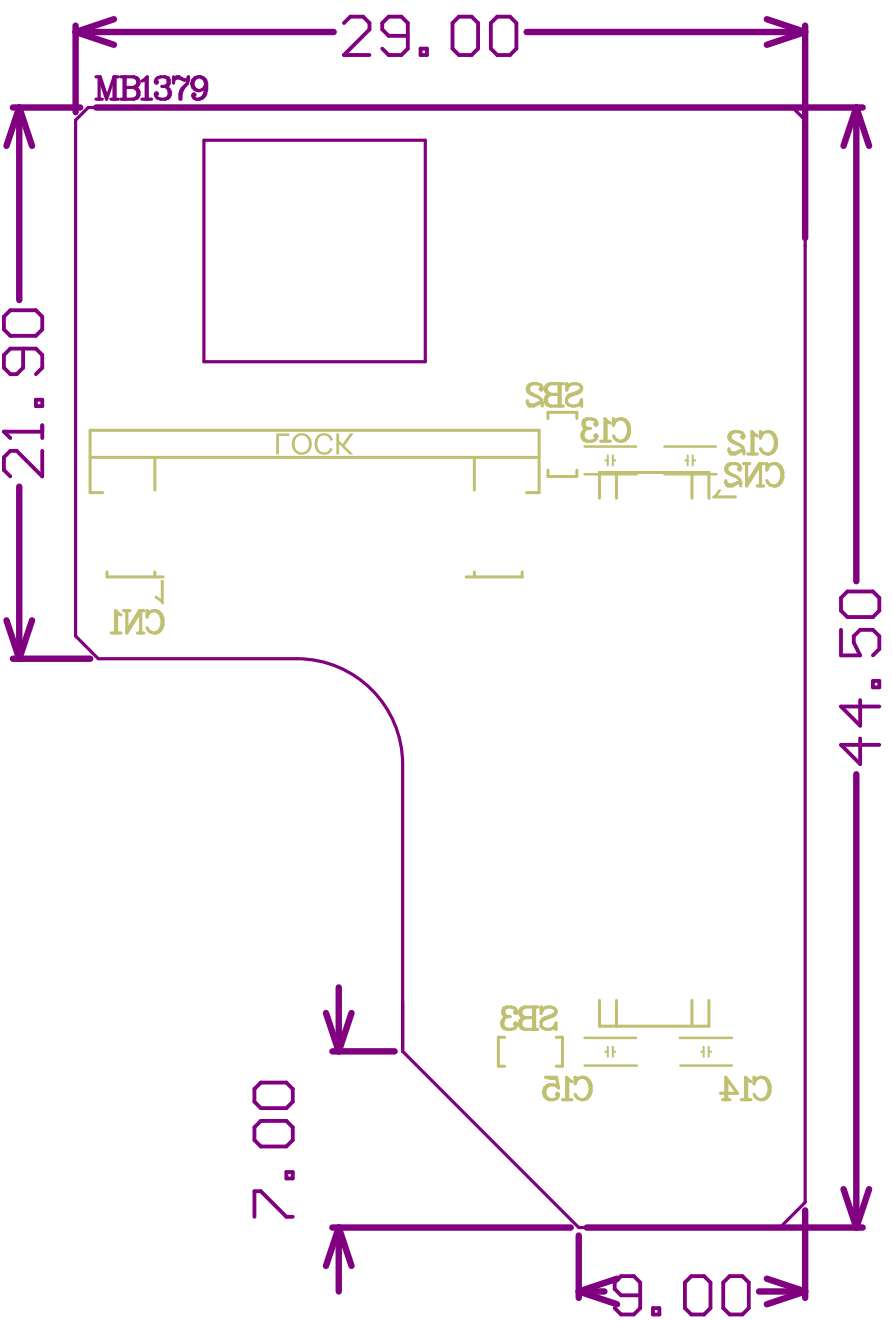


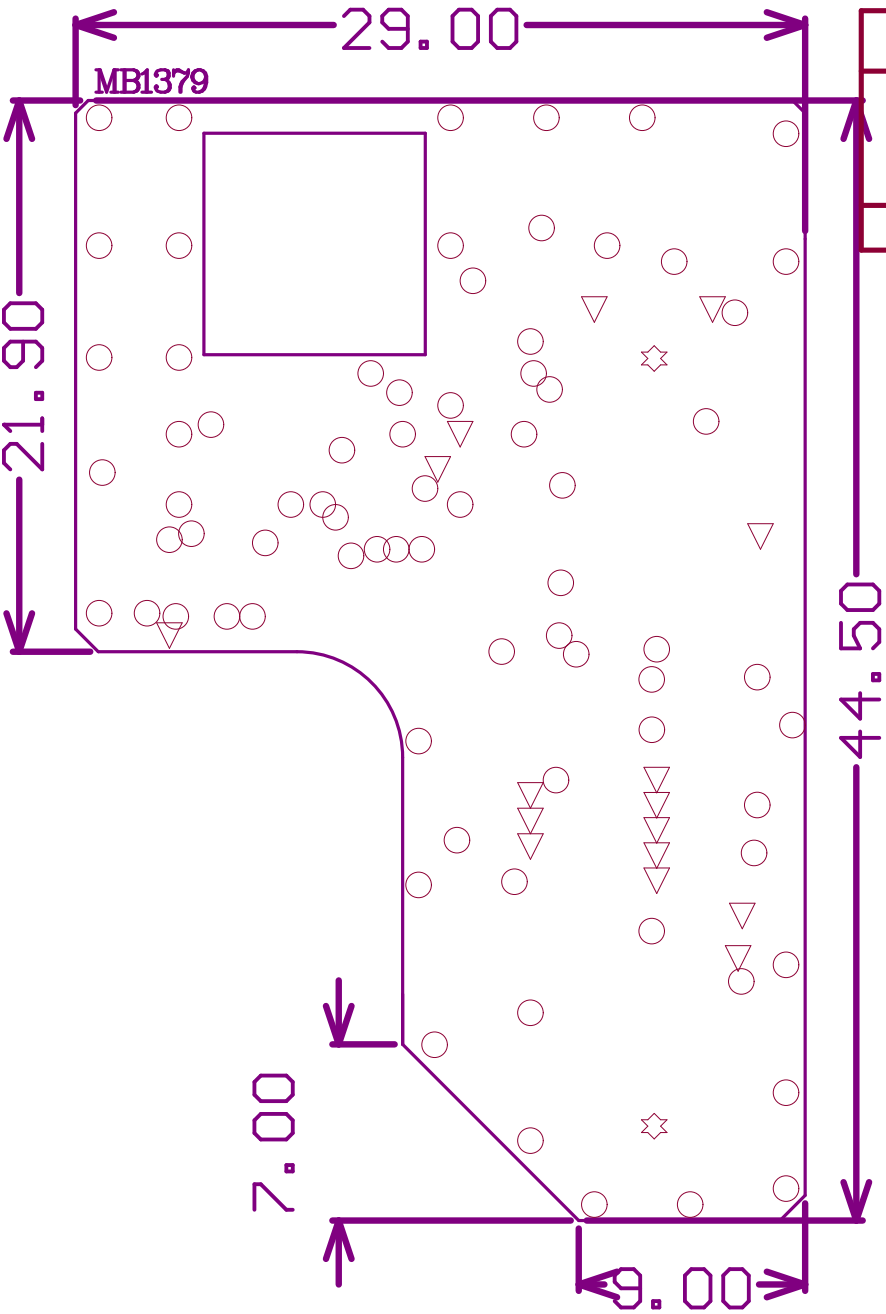












Symbol	Hit Count	Tool Size	Plated	Hole Type
▽	16	0.2mm (7.874mil)	PTH	Round
○	75	0.203mm (8mil)	PTH	Round
☆	2	3.2mm (125.984mil)	PTH	Round
	93 Total			

Layer Stack Up Detail for: MB1379.PcbDoc						
Layer Name	Berber Document	Copper Thickness	Dielectric Height	Dielectric Material	Dielectric Constant	Dielectric Type
Top Solder Mask	<.GTS>		0.4mil	Solder Resist	3.50	
Top Layer	<.GTL>	1.4mil	59.055mil	FR-4	4.80	Core
Bottom Layer	<.GBL>	1.4mil				
Bottom Solder Mask	<.GBS>		0.4mil	Solder Resist	3.50	